

# RPC Phase II Upgrade: Project Planning and Execution



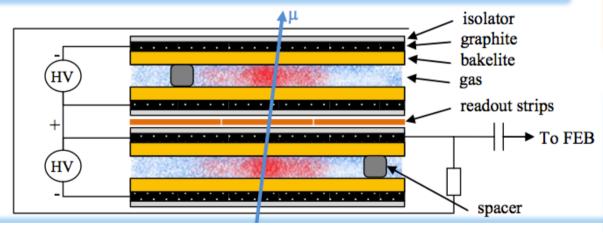


## Present RPC System

## Robust, efficient and redundant muon system <sub>§</sub>

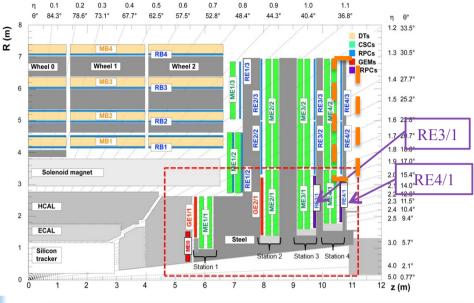
#### RPC present system (with RE4 installed in LS1)

- $\triangleright$  Covers  $0 < |\eta| < 1.6$
- ➤ 1056 chambers (480 in barrel and 576 in endcap)
- ➤ 123688 electronic channels and 3950 m² of active area
- **Double gap chamber:** 2 mm gas width
- **Bakelite** bulk resistivity:  $\rho = 2 5 \times 10^{10} \Omega \text{cm}$
- $\triangleright$  Strip width: 1 4 cm.
- Sas mixture:  $C_2H_2F_4 + isoC_4H_{10} + SF_6$  (40% of H) 95.2% 4.5% 0.3%
- ➤ Operated in avalanche mode



#### 2015 data

Spatial resolution  $\approx 1$  cm Time resolution  $\approx 2$  ns Av. Electronic Noise ~ 0.13 Hz/cm<sup>2</sup> Av. Efficiency ~ 94%



#### CMS muon upgrade

> RPC system completion up to  $|\eta| < 2.4$  in phase 2

#### μ RPC system priorities

- μ Identification
- Triggering
- Improve High-p<sub>T</sub> measurement (inner Tracker dominates up to ~200 GeV)
- Displaced delayed muon reconstruction



## Outline

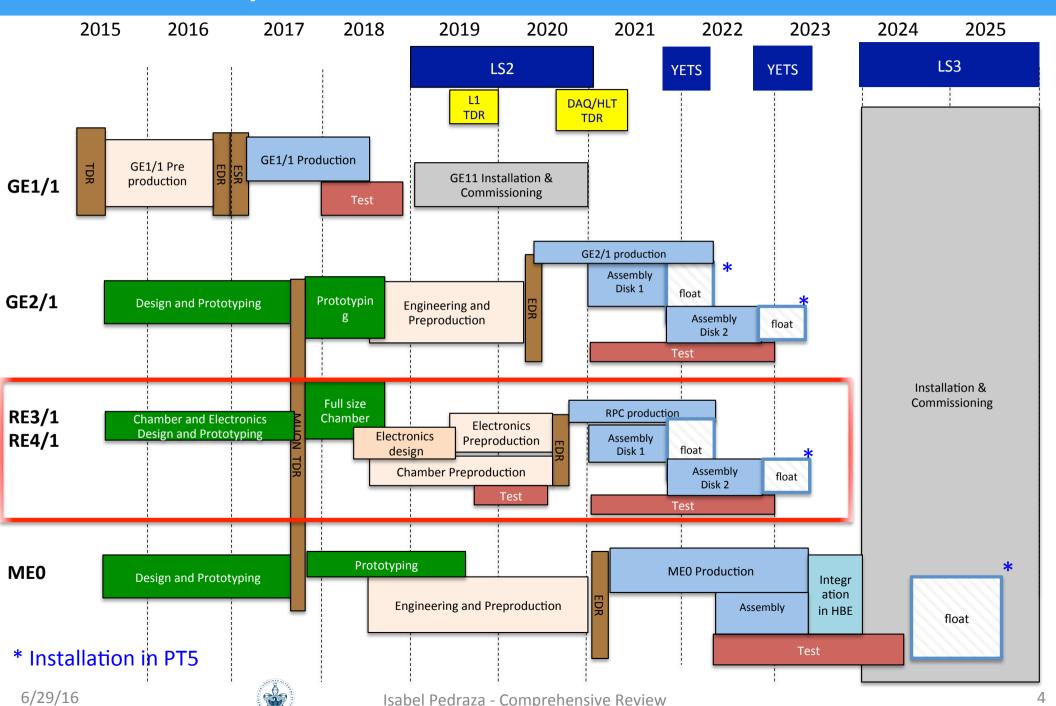
## In this talk the following charges for the first Comprehensive Review of the CMS Muon Phase II upgrade is described

- [charge 8] Time line up to the TDR, EDR, and ESR
- Charge 8 | Project planning and milestones program up to TDR, EDR, ESR
- [charge 8] Strategy for design decision
- [charge 8] Draft of construction plan
- [charge 8] Resources

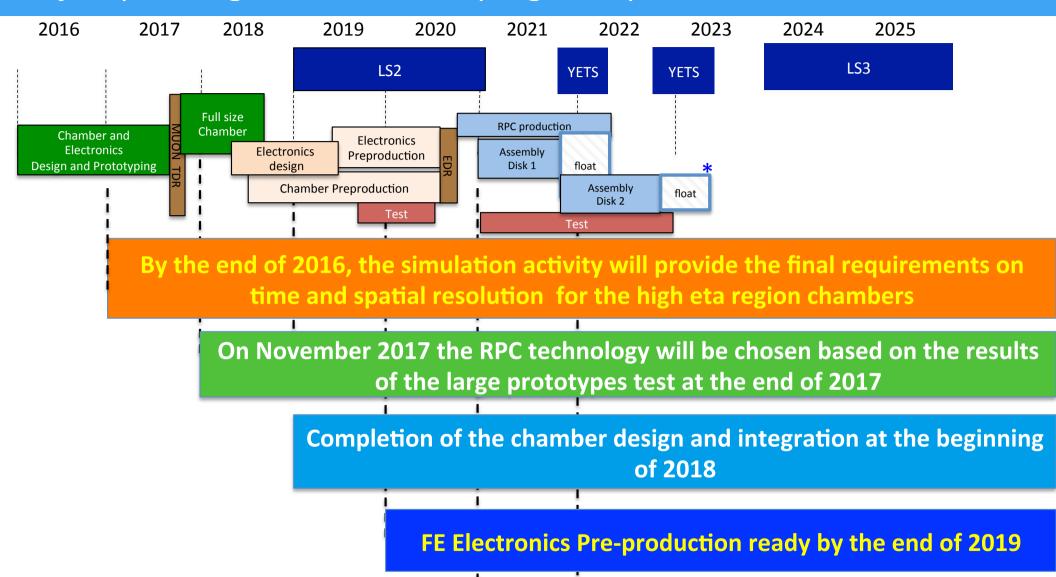


#### [charge 8]

## Time line up to the TDR, EDR, and ESR



#### Project planning and milestones program up to TDR, EDR, ESR



**Chamber production starts late 2020** 

Ready to Install the first end-cap by December 2021 during the EYETS



## High and Low level milestones up to EDR

ARPC Assessment of performance of small prototype (LM) ARPC mechanical design and integration in CMS (LM)  ARPC power system specs ready for TDR (LV) (LM)  ARPC Fed design finalized (HM)  April 10, 2018  ARPC Chamber Ged finalized (HM)  April 10, 2018  ARPC Chamber ready for pre-production (HM)  ARPC Fed design ready (LM)  ARPC L1 and readout design feady (LM)  ARPC L2 and HV Power Supply pre-production validated (LM)  ARPC L2 and HV Power Supply pre-production validated (LM)  ARPC L2 and HV Power Supply pre-production validated (LM)  ARPC Fed design Review (HM)  ARPC L2 and HV Power Supply pre-production validated (LM)  ARPC Fed design Review (HM)  ARPC Fed design Review (HM)  ARPC L2 and HV Power Supply pre-production validated (LM)  ARPC Fed design Review (HM)  ARPC Fed d		5 1 .		
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ARPC simulation: assessment of performance requirements from simulation HM)  ARPC Power system specs ready for TDR (LV) (LM)  ARPC FEd design finalized (HM)  ARPC Review L1 and readout design done (LM)  ARPC Full size prototypes assembly procedure assessed (LM)  AUJU 5, 2017  AUGUST 29, 2017  A	RPC Assessment of performance of small prototype (LM)	·		
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	RPC Engineering Design Review (HM)	October 22, 2020	EDR	



DATES	Beam Status Goals					
4/15/16 Lyon RE1/1 Chamber to test the CMS electronics at 904 and the RPC with Lyon Electronics for Consolidation						
April 18, 2016 May 11, 2016	Test Beam GIF++ Main Users	Commisioning of DAQ and DCS systems				
Data Analysis and results						
5/20/16	Lyon RE1/1 Chamber					
May 25, 2016 June 8, 2016		Rate capability study on small GRPC and backelite RPC				
Data Analysis and results						
	Tisinghua Multigap RPC KODEL 2 Backelite RPC					
August 10, 2016 August 24, 2016	Test Beam GIF++ / RD51	Performance study on MGPC and Backelite RPC (thinner gap & electrodes)				
Data Analysis and results						
August 31, 2016 September 14, 2016	Test Beam GIF++ Main Users	Rate capability, test of petiroc, and time resolution				
Data Analysis and results						
September 28, 2016 October 12, 2016	Test Beam GIF++ / RD51	Performance study on GRPC large prototype				

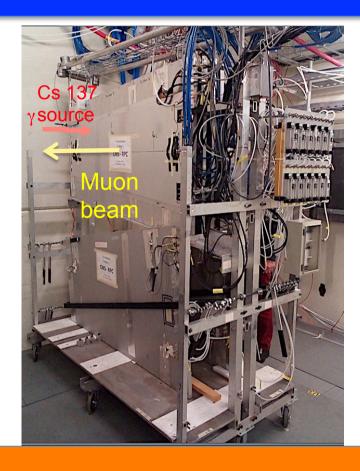
Data Analysis and results

December 15, 2016 RPC Assesment of performance of small prototype (LM)

RPC Review of the mechanical design and integration in CMS (LM) December 15, 2016

December 22, 2016 RPC assessment of performance requirements from simulation (HM)

## RPC R&D at GIF++ in a HL-LHC like environment

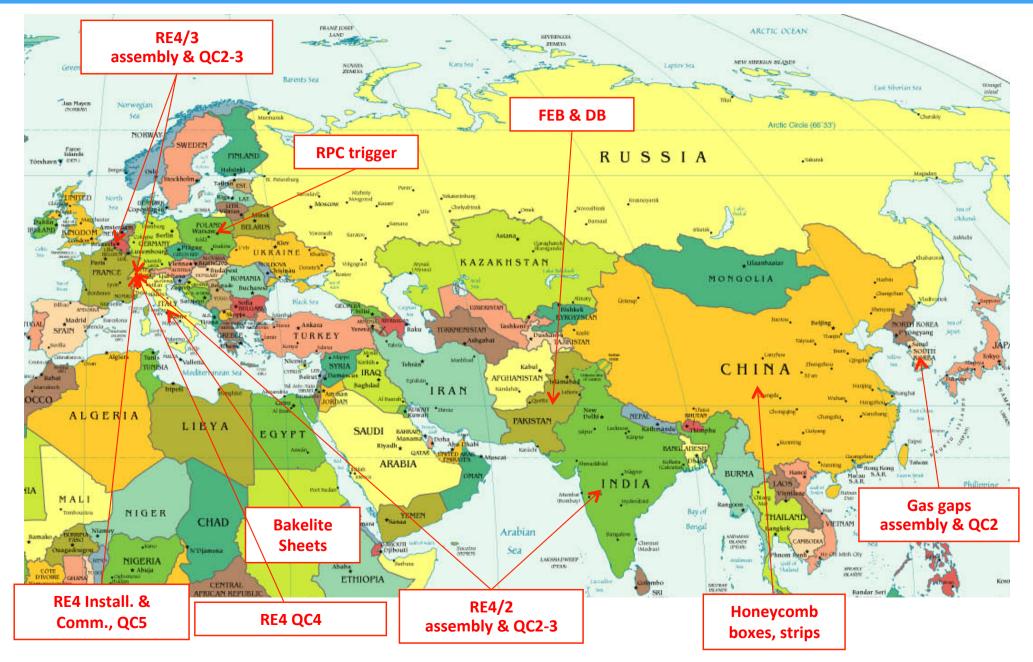


Clear calendar of test and expected results for the different prototypes and configurations



	❖ All RE3/1 & RE4/1 service installation activities.						ation activities			
Service	Weeks	Installation		All NL3/1 & NL4/1 Service installation activi				ation activities.		
		LS2 Perio	od	CMX ZEC CSC RE DT+ RB TK FPIX Survey HCAL TE-VSC EN Dept GS Dept				SC EN Dept GS Dept RP		
HV Umbilical cables	4	RE+: W16- RE-: W47-		Week 18						
HV power cables	4	RE+: W18- RE-: W49-	_	I I I I I I I I I I I I I I I I I I I		cables FAR	Repair DT MiniCrates			
LV power cables		RE+3/1: W		2/day W2/4			YB-2-1 w3/4	<sup>3/4</sup>		
DCS cables	4	RE+4/1: W RE-3/1: W				M				
LVDS signal cables		RE-4/1: W	1							
Gas copper pipes	2	RE+: W1 <sup>-</sup> RE-: W4	-				Remove 18 ME-2/1 chambers 2d 4/4d			
Supply Gas copper pipes	4	RE+3/1: W RE+4/1: W3		Install F	RE+3/1 H\	/ cables NEAR		Move YE-2  1d  Disconnect ME-3/1 services		
Return Gas copper pipes		RE-3/1: W RE-4/1: W2						2d 2/3d  Shutdown/Technical stop Protons physics		
				CP		Possible	date	Commissioning Ions		
2015 2016		2017	:	2018		2019	2020	2021		
J F M A M J J A S O N D J F M A M J J A S	OND J F M EYETS		J F M A	MJJASOND	J F M	LS2	JFMAMJJASOND	J F M A M J J A S O N D		

## **Experience with RE4 Production (ended 2014)**





## Lessons learned

- Effective interaction with the industry.
- Successful overseas collaboration.
- Meetings every week.
  - Very different time zones

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GTM-6
GMT+1 → Geneva
GMT+8
GMT+9
```

- Day by day calendar of activities.
- Shipments and product safety protocols established.
- Well defined quality controls and acceptance thresholds on components and chambers performance



## [CHARGE 8] DRAFT OF CONSTRUCTION PLAN



11

## QC1 (components)

#### Electrode Production HPL/Glass Production site:

- Panel Cut, surface inspection, polishing (HPL).
- Thickness, roughness, color, labeling/DB, signal cable (Glass)

#### Chamber Elements Production. At Assembly sites:

- Front End Boards (FEB) testing.
- Cooling system, mechanics and readout strip testing.

#### QC2 (RPC gaps)

#### Gaps Production. At Assembly sites:

- Visual Inspection, Gas tightness and spacer test
- Electrical and dark current, resistivity measurement (sample)

## <del>-</del>

#### QC3

(RPC chambers)



#### QC4

(Final Chamber Test)

#### Chamber Assembly. At sites:

- Visual Inspection, Gas tightness, Electrical and dark current
- Connectivity test, Cosmic muon commissioning

#### At CERN final chamber tests:

- Detector acceptance for CMS
  - Leak test, Connectivity, Cooling circuit tests, Long term detector operation at Working Point, Electric and dark current tests



## **Electrodes and Gap Production**

#### Chamber production starts late 2020

**Production and Qualification of HPL and Gaps** 

Experience on process reliability and object inside specification ranges from RE4-3/2

Production at Puricelli (Milan)

1

Electrodes Quality Control at INFN (Pavia)

2

Panel cut at RIVA (Milan)

3

Surface cleaning at General-Tecnica (Frosinone) 4

Gap Production (Kodel, Korea)

Gap Quality Control (Kodel,

Korea)







Puricelli production site in Costamasnaga (Milan, Italy)

**Korea University facility for gluing and oiling** 



## **Electrodes and Gap Production**

Glass RPC (New for CMS): Production and Qualification

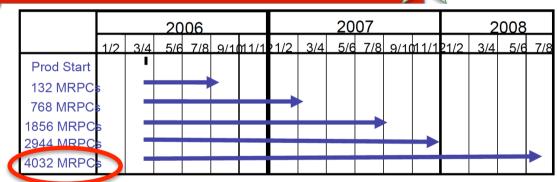
 Multi glass RPC are already under construction by the same group for the CBM (Compressed Baryonic Matter) Experiment



Production at China (Nuctech and Tsinghua)

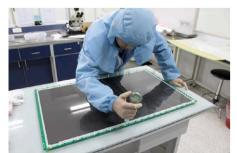
Mass production yields >100m²/month

Electrodes and gap Quality Controls (Nuctech, Tsinghua)



Experience:
More than 4K
mgaps produced







The "TUMUTY" (Tsinghua University Muon Tomography)

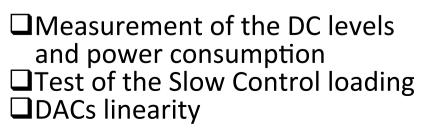
\*http://www.nuctech.com/en/index.aspx

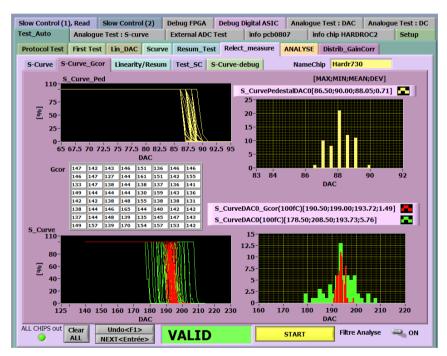


## **Electronics: HARDROC production**

- ☐ ~10 500 chips produced and tested at IPNL Lyon for the SDHCAL project (2 months).
- □ Dedicated Labview program, USB interface, testboard, programmable generator (GPIB), precise multimeter (Keithley)







☐Trigger efficiency measurement

Pedestal for the 3 shapers

□ 100 fC trigger efficiency measurement for fsb0 + gain correction for each channel

☐1 pC trigger efficiency measurement for fsb1 and fsb2



## Chamber assembly and test



- Expect to have more than one assembly and test sites
- There are experienced people in several sites within the RPC collaboration
- Still operational infrastructure for assembly and cosmic test facilities in several sites.
- Recent refurbished RPC laboratory at Prévessin in 904 building. Cosmic stand and the infrastructure for the stability tests ready.

## **INSTALLATION**



### Experience from RE4-2/3

- RE4-2/3 (144 Chambers) is twice the production of RE4-1/3-1 (72).
- The installation negative end-cap end of December 2014.





#### **Preliminary installation schedule**

#### For disk of RE3/1 or RE4/1

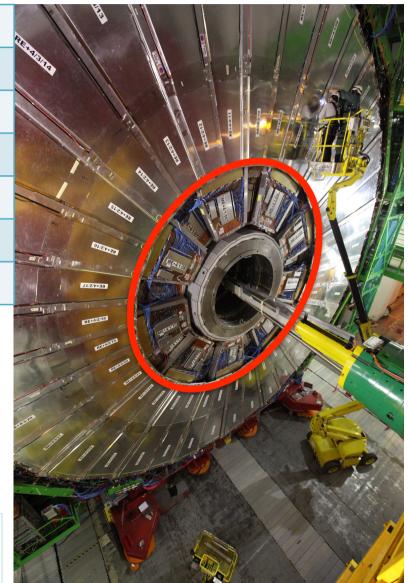
Action	Days
Crane needed	Full time
18 (of 72) chambers installed	3
Cable (HV/LV,Signal)	3
Cooling and commissioning at 18 bar with gas	4
Gas	3
Final chamber commissioning	7

## Total installation/commissioning time ~ 3 weeks (including w.e.)

Job on different disks can be parallelised if manpower available.

Services installed during LS2 and/or EYETS
Chambers to be installed 1-2 disks during EYETS



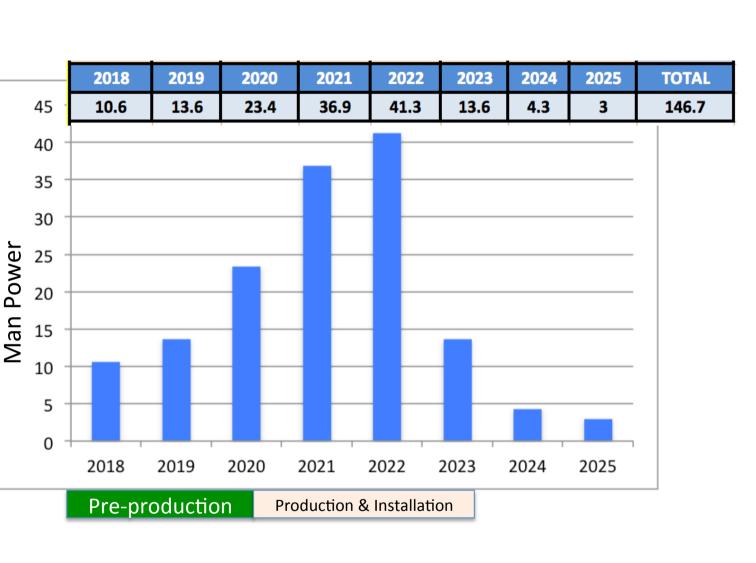


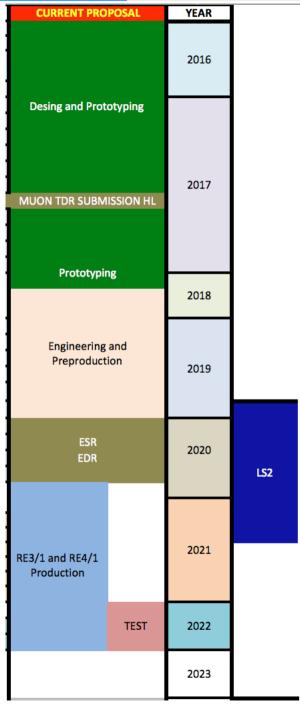
## **DRAFT OF RESOURCES**



#### Expected resources needed: Man power

#### [charge 8]





## Plus R&D Man Power

#### 2015 - 19 People

 ✓ Hardware installation and development and commissioning of DAQ, DCS, DQM at GIF++

#### 2016 - 19 people

- Test Beam, WebDCS and Offline Data Analysis
- ❖ Test beam outsite GIF++

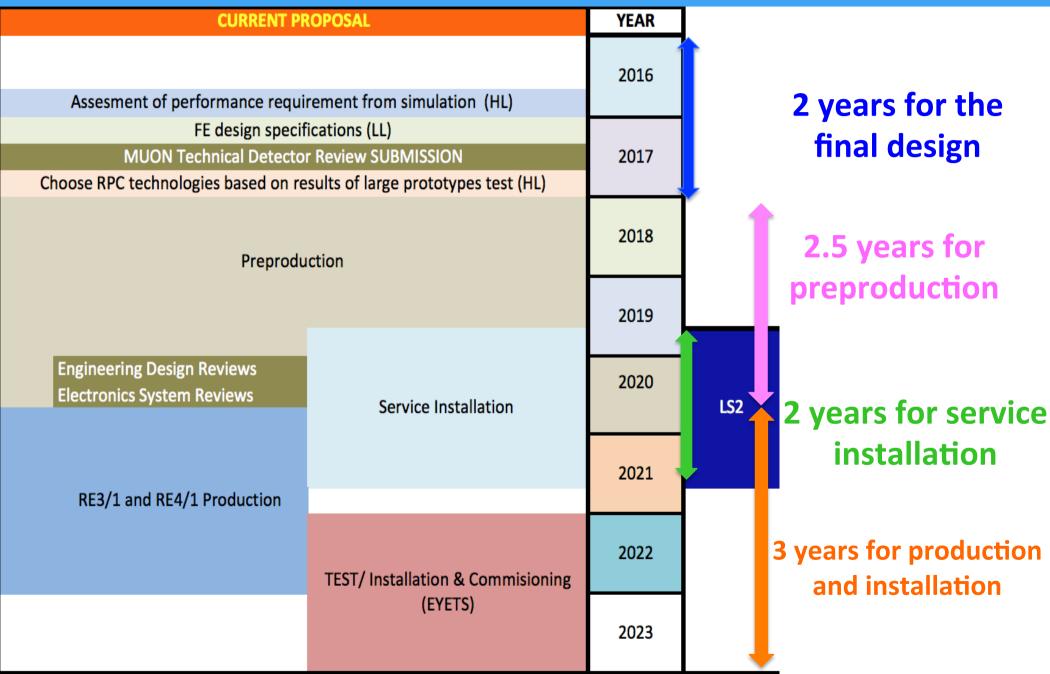


Currently all the institutions interested on the RE4-1/3-1 constructions are actively involved in the GIF++ activities.

GIF++ activities are the starting point for the new institutions that will join the construction and the operations



## RPC Timeline and installation plans



## Conclusions

- Resources and planning have been established.
- Expected time line :
  - Final performance requirements from simulation end of 2016
  - Mechanical design and integration end of 2016
  - FE design specifications first quarter of 2017
  - Choose RPC technologies based on results of large prototype end of 2017
  - Start pre-production in 2018
  - Service installation in LS2
  - FDR and FSR 2020
  - Production Starts at the end of 2020
  - Installation in EYETS 2022-2023
- The relative cost impact of the different options has been estimated.
- We are following a very well consolidated schema of production, test and quality control applied recently for the RE4 construction

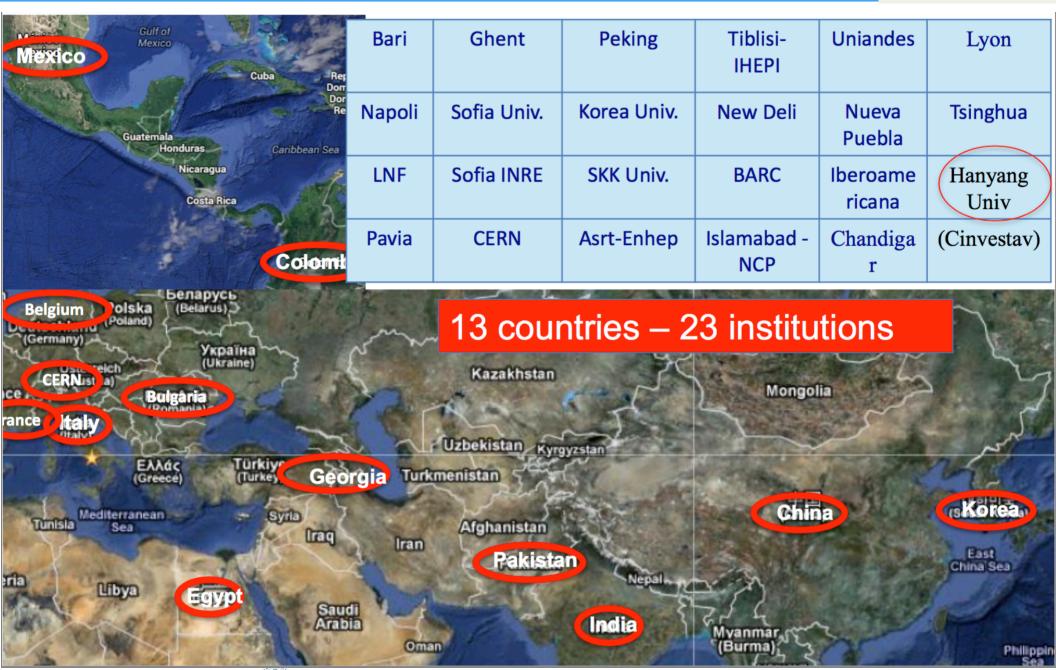


## Backup



### Current members of the RPC community

#### [charge 8]



## Software Activities

Description	Start date
PC Simulation	01/01/16
RPC Simulation: Local reconstruction	01/01/16
RPC simulation: Sensitivity and hit rate simulation for iRPC detectors	01/01/16
RPC simulation: Adding additional features to RPCDigi (2D position, precise timing, etc.)	01/01/16
RPC simulation: Parallel pseudo-digitization to study the spatial and time resolution of iRPCs	01/01/16
RPC simulation: Adding additional features to reconstructed hit (2D position, precise timing, etc.)	29/04/16
RPC simulation: Development of new digitization model to accommodate different detector technologies (precise timing, 2D strip readout, readout from both sides)	27/05/16
RPC simulation: Developing of new local reconstruction algorithm to work with the new digis (precise timing, TOF information, 2 D readout, etc.)	28/07/16
RPC simulation: Implementation of new detector geometries and realistic digitization	30/09/16
RPC simulation: integration of local reconstruction in the STA muon reconstruction and RPCmuo	on 24/11/16
RPC simulation: assessment of performance requirements from simulation (HM)	22/12/16

The simulation activity will provide the requirements for the high eta region chambers by the end of 2016



#### Development activities: Chamber Design

[charge 8]

Description	Start date
RPC Developments	01/01/16
RPC Chamber R&D	01/01/16
RPC: Small prototype tests	01/01/16
RPC test with beam and irradiation at GIF++	01/01/16
RPC Assessment of performance of small prototypes (LM)	15/12/16
RPC mechanical design and integration in CMS (LM)	15/12/16
RPC full size prototypes assembly	04/01/17
RPC: full size prototype tests	12/04/17
RPC full size prototype test in lab	12/04/17
RPC full size prototype test at GIF++, beam test	10/05/17
RPC full size prototypes and FE prototypes tested with beam: preliminary results for TDR (LM)	29/08/17
RPC full size prototypes assembly procedure assessed (LM)	05/07/17
RPC full size prototypes assembled and tested (LM)	05/12/17
RPC Assessment of technology options (HM)	05/12/17

Choose RPC technologies based on results of large prototypes test at the end of 2017



#### Development Activities: Electronics & Cooling

Description	Start date
RPC FE developments	24/03/16
RPC FE	24/03/16
RPC FE prototypes design and developments	24/03/16
RPC PCB prototypes design and production	24/03/16
RPC FE prototypes validation with chamber in lab	12/04/17
RPC FE design finalized (HM)	05/07/17
RPC Back-End Systems Developments	24/03/16
RPC Trigger/Readout Development	24/03/16
RPC Review of L1 and readout design	24/03/16
RPC First Review of L1 and readout design done (LM)	15/06/16
RPC First L1 and readout design	15/06/16
RPC Second Review L1 and readout design done (LM)	05/07/17
RPC Power distribution Development	05/07/17
RPC Power system specs ready for TDR (LV) (LM)	05/07/17
RPC Power system specs ready for TDR (HV) (LM)	29/08/17
RPC Chamber Cooling	05/07/17
RPC Chamber Cooling: system design	05/07/17
RPC Chamber Cooling: Demo circuit built	30/08/17
RPC Chamber Cooling: Preliminary Design ready (LM)	06/12/17
RPC final prototype assembly	05/12/17
RPC Completion of chamber design and integration (HM)	10/04/18
RPC: final prototype tests	11/04/18
RPC final prototype tests in the lab	11/04/18
RPC final prototype test with beam at GIF++	08/05/18
RPC Longevity studies from irradiation tests for final prototype	25/09/18

#### FE design specifications by the beginning of 2017



#### **Description** Due date

RPC FE proto design 05/0	07/17 07/17 07/17 02/19 02/19
RPC FE proto design 05/0	07/17 02/19 02/19
	02/19 02/19
DDC EE design ready (LM)	02/19
HPO 1 E design ready (Livi)	
RPC FE market suvey 18/0	02/19
RPC FE Selection of companies 18/0	
RPC FE Close Market Survey (LM) 19/0	05/19
RPC FE pre-production submission 20/	05/19
RPC FE pre-production testing 01/	11/19
RPC FE pre-production final validation at irradiation facilities (GIF++, reactors etc) 01/	11/19
RPC On-Chamber FE Electronics Pre-production Ready (LM) 27/	12/19
RPC Back-end System pre-production 05/0	07/17
RPC L1 and readout design 05/	07/17
RPC Power Supply pre-pre-production 18/0	02/19
RPC LV and HV Power Supply pre-production design 18/0	02/19
RPC LV and HV Power Supply pre-production order 08/	07/19
RPC LV and HV Power Supply pre-production testing 30/	09/19
RPC LV and HV Power Supply pre-production validated (LM) 27/9	04/20
RPC L1 and readout design ready (LM) 18/0	02/19
RPC L1 and readout demo development 18/0	02/19
RPC L1 and readout pre-production submission 14/	04/20
RPC L1 and readout pre-production testing 01/	09/20
RPC L1 and readout pre-production Ready (LM) 23/	11/20
RPC Chamber pre-production 25/	09/18
RPC Chamber ready for pre-production (LM) 25/0	09/18
RPC Chamber Pre-production assembly 26/	09/18
RPC Chamber Pre-production tests 28/	03/19
RPC Chamber Pre-production tests with pre-production electronics 28/	04/20
RPC Pre-production Chamber and Electronics Ready (HM) 23/	11/20

#### Pre-production is expected to start at the beginning of 2018



### **Production & Installation Activities**

Description	Start date
RPC Production and commissioning	24/11/20
RPC FE Production	24/11/20
RPC On-chamber Electronics (FE) Production and testing	24/11/20
RPC On-chamber Electronics (FE) ready (HM)	11/05/21
RPC Chamber Production	24/11/20
RPC Chamber PRR	24/11/20
RPC Chamber Production and QC 1-2	07/12/20
RPC Back-end System Production	24/11/20
RPC Back-end Electronics Production and testing	24/11/20
RPC Back-end Electronics ready (HM)	01/02/22
RPC Chambers Ready for Assembly Endcap 1 (HM)	13/04/21
RPC Detector with On-chamber Electronics Assembly, Testing and QC 3-4 Endcap 1	14/04/21
RPC Chambers Ready for Assembly Endcap 2 (HM)	07/12/21
RPC Detector with On-chamber Electronics Assembly, Testing and QC 3-4 Endcap 2	2 08/12/21
RPC installation	25/03/19
RPC Services installation Disk+1 in LS2 shutdown (EM)	25/03/19
RPC Services installation Disk-1 in LS2 shutdown (EM)	01/10/19
RPC Detector Ready for Installation Endcap 1 (HM)	07/12/21
RPC Installation time window from TC Endcap 1	08/12/21
RPC Installation date from TC Endcap 1 (RM)	22/03/22
RPC Detector Ready for Installation Endcap 2 (HM)	06/12/22
RPC Installation time window from TC Endcap 2	07/12/22
RPC Installation date from TC Endcap 2 (RM)	31/03/23

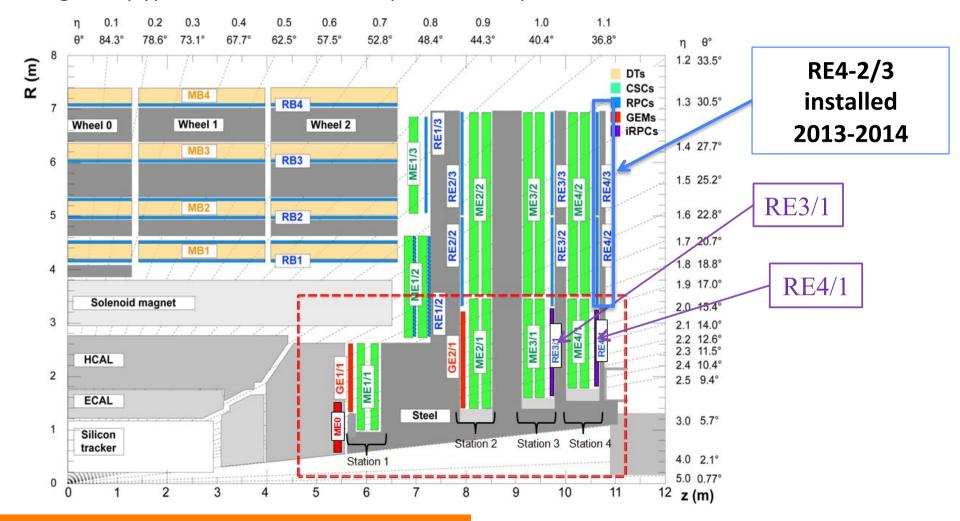
Chamber production starts late 2020 Installation expected during the EYES in 2022 & 2023



## Overview

#### New RPC chambers = "improved" RPC (iRPC):

covering 1.8< $|\eta|$ <2.5; each chamber spans 20° in  $\varphi$ 

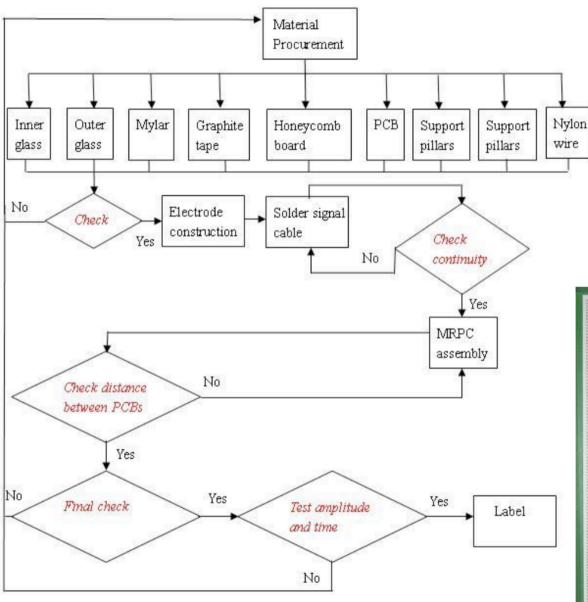


All existing chambers are double gap backelite.



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#### Procedures of construction and QC for MGRPC



6S criterion, ISO 9000 and 14000 standards are also carried out in MRPC production.

ISO14001

**ISO9001** 



## **About Nuntech**



#### Over 80,000m<sup>2</sup> Plant Building

















#### **Manufacturing Ability**

Located in the northeast part of Beijing, the base is 80km away from Tsinghua, which includes

- Accelerator Workshop
- Electronic Workshop
- Assembly Workshop
- Customer Training Center

•••

The base is equipped with advanced manufacture, installation and testing facilities along with scientific management. The main functions of the base are

- Manufacture
- System research and development
- Professional Customer training

sity of Technology, Austria



### RE3/1 & RE4/1 Service Installation

❖ All RE3/1 & RE4/1 service installation activities are well planned and scheduled in the CMS LS2 planning.

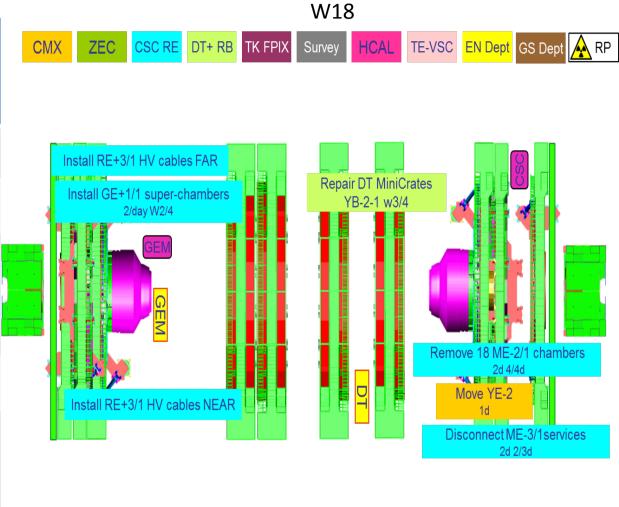
Power System Component	Total Quan tity	Length/ Diam [m/mm]	Start Point	End Point	Cable chain occupan cy	Service Installation Duration	Installation LS2 Period	
HV Umbilical cables	8	~90/40	S1H*	X1 YE1 HV PP	Main CC	2 weeks per end	RE+: W16-17 RE-: W47-48	
HV power cables	72	~30/6	X1 YE1 HV PP	chambers	18 cables per mini CC	2 weeks per end	RE+: W18-19 RE-: W49-50	
LV power cables	72	~15/10	towers	chambers no	no	1 week per station & end	RE+3/1: W51 RE+4/1: W57	
DCS cables	72	~15/5	towers				· · · · · · · · · · · · · · · · · · ·	RE-3/1: W38 RE-4/1: W44
LVDS signal cables	1440	~15/10					NE 1/ 1. W	
Gas copper pipes	4	~110/12	S1L* tbc	X2A51 X2S51	Main CC	1 week per end	RE+: W17 RE-: W48	
Supply Gas copper pipes	24	~20/6	X2A51	chambers	no	1 week per station	RE+3/1: W50 RE+4/1: W39-40	
Return Gas copper pipes	24	~20/8	X2S51 CII	5.141110613	1.0	& end	RE-3/1: W37 RE-4/1: W20-21	
Cooling	tbc				no			



### RE3/1 & RE4/1 Service Installation

❖ All RE3/1 & RE4/1 service installation activities are well planned and scheduled in the CMS LS2 planning.

Power System Component	Total Quanti ty	Service Installati on Duration	Installation LS2 Period
HV Umbilical cables	8	2 weeks per end	RE+: W16-17 RE-: W47-48
HV power cables	72	2 weeks per end	RE+: W18-19 RE-: W49-50
LV power cables	72		RE+3/1: W51
DCS cables	72	1 week per station &	RE+4/1: W57 RE-3/1: W38
LVDS signal cables	1440	end	RE-4/1: W44
Gas copper pipes	4	1 week per end	RE+: W17 RE-: W48
Supply Gas copper pipes	24	1 week per	RE+3/1: W50 RE+4/1:
Return Gas copper pipes	end		W39-40 RE-3/1: W37 RE-4/1: W20-21
Cooling	tbc		

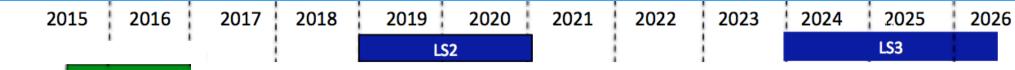




High and Low level milestones	Due date	STAGE		YEAR	
RPC Assessment of performance of small prototype (LM)	December 15, 2016	SIAGE			
RPC mechanical design and integration in CMS (LM)	December 15, 2016			2016	
	December 22, 2016			2016	
RPC simulation: assessment of performance requirements from simulation (HM)	December 22, 2016				
RPC Power system specs ready for TDR (LV) (LM)	July 5, 2017	Chamban and Electronic	. Davis and	2017	
RPC FE design finalized (HM)	July 5, 2017	Chamber and Electronic Prototyping			
RPC full size prototypes assembly procedure assessed (LM)	July 5, 2017				
RPC Review L1 and readout design done (LM)	July 5, 2017				
RPC Power system specs ready for TDR (HV) (LM)	August 29, 2017				
	August 29, 2017				
RPC full size and FE prototypes tested with beam: preliminary results for TDR (LM)					
MUON Technical Detector Review SUBMISSION (HM)	September 14, 2017	TDR			
RPC full size prototypes assembled and tested (LM)	December 5, 2017				
RPC Assessment of technology options (HM)	December 5, 2017			1	
RPC Chamber Cooling : Preliminary Design ready (LM)	December 6, 2017	Full size Cham	ber		
RPC Completion of Chamber design and integration (HM)	April 10, 2018	Electronics and Chamber Preproduction		2018	
RPC Chamber ready for pre-production (LM)	September 25, 2018				
				2019	
RPC FE design ready (LM)	February 18, 2019				
RPC L1 and readout desing ready (LM)	February 18, 2019				
RPC FE Close Market Survey (LM)	May 19, 2019				
RPC On-Chamber FE Electronics Pre-production Ready (LM)	December 27, 2019				
RPC LV and HV Power Supply pre-production validated (LM)	May 27, 2020				LS2
RPC Electronics System Review (HM)	October 22, 2020	ESR			
RPC Engineering Design Review (HM)	October 22, 2020	EDR		2020	
RPC L1 and readout pre-production ready (LM)	November 23, 2020				
RPC Pre-production Chamber and Electronics Ready (HM)	November 23, 2020				
RPC Chambers Ready for Assembly Endcap 1 (HM)	April 13, 2021				
RPC On-Chamber Electronics(FE) ready (HM)	May 11, 2021		'1 and RE4/1 on & Installation	2021	
RPC Chambers Ready for Assembly Endcap 2 (HM)	December 7, 2021	RE3/1 and RE4/1			
RPC Back-end Electronics ready (HM)	February 1, 2022	Production & installation			
RPC Detector Ready for Installation Endcap 1 (HM)	December 7, 2021				
	Docomber C 2022		TECT	2022	
RPC Detector Ready for Installation Endcap 2 (HL)	December 6, 2022		TEST	2022	
				2022	
				2023	
		Instalation & Commissioning		2024	
				2025	LS3
				2026	



## Design and Prototyping: Simulation Milestones



RPC



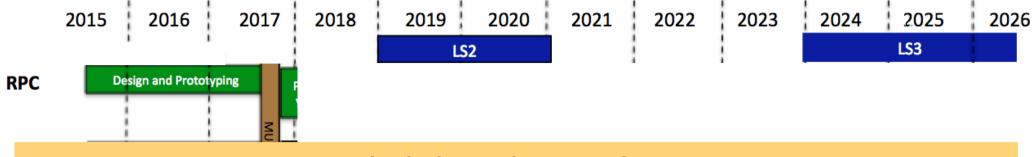
### 2016 mainly dedicated to simulation studies

LL		June 15, 2016
LL		December 15, 2016
	HL	December 22, 2016
LL		December 15, 2016
	LL	LL

By the end of 2016, the simulation activity will provide the requirements on time and spatial resolution for the high eta region chambers



## Design and Prototyping: Development milestones



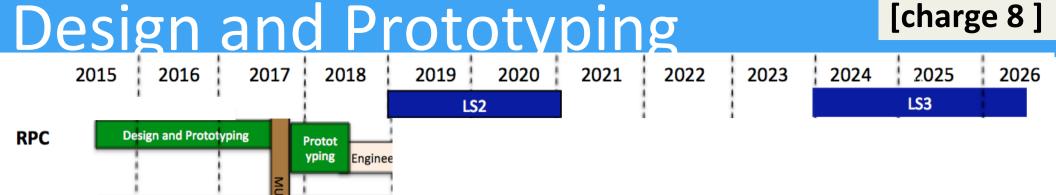
### 2017 mainly dedicated to test the prototypes

-			
RPC Power system specs ready for TDR (LV) (LL)	LL		June 23, 2017
RPC FE design finalized (LL)	LL		June 23, 2017
RPC full size prototypes assembly procedure assessed (LL)	LL		June 23, 2017
RPC Second Review L1 and readout design done (LL)	LL		June 28, 2017
RPC Power system specs ready for TDR (HV) (LL)	LL		August 17, 2017
RPC full size prototypes tested with beam: preliminary results for TDR (LL)	LL		August 17, 2017
RPC full size prototypes assembled and tested (LL)		LL	November 23, 2017
RPC Assessment of technology options (HL)		HL	November 23, 2017

On November 2017 the RPC technology will be chosen based on the results of the large prototypes test at the end of 2017

FE design specifications by the beginning of 2017





Completion of the chamber design and integration at the beginning of 2018

Pre-production is expected to start in the middle of 2018

Final prototype test in the lab and at GIF++

Chambers ready for pre-production



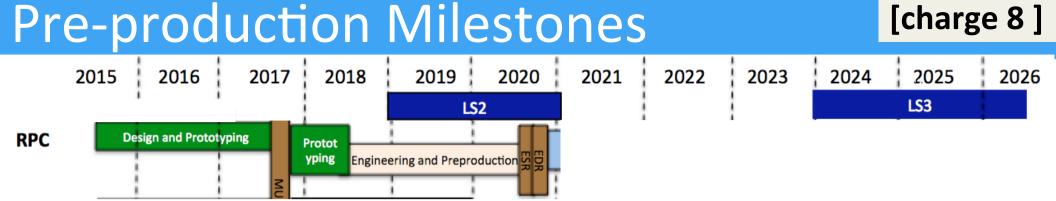


## 2019 focus to get ready for preproduction

RPC FE design ready (LL)	LL	February 18, 2019
RPC L1 and readout desing ready (LL)	LL	January 9, 2019
RPC FE Close Market Survey (LL)	LL	May 19, 2019
RPC On-Chamber FE Electronics Pre-production Ready (LL)	LL	December 27, 2019

# FE Electronics Pre-production ready by the end of the 2019



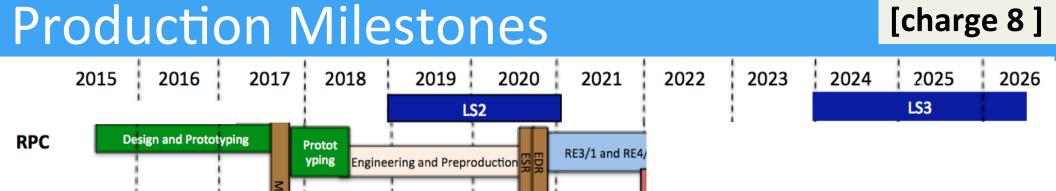


## 2020 focus on getting ready for production

RPC LV and HV Power Supply pre-production validated (LL)	LL		March 12, 2020
RPC ESR (HL)		HL	October 22, 2020
RPC EDR (HL)		HL	October 22, 2020
RPC L1 and readout pre-production ready (LL)	LL		October 14, 2020

## Chamber production starts late 2020



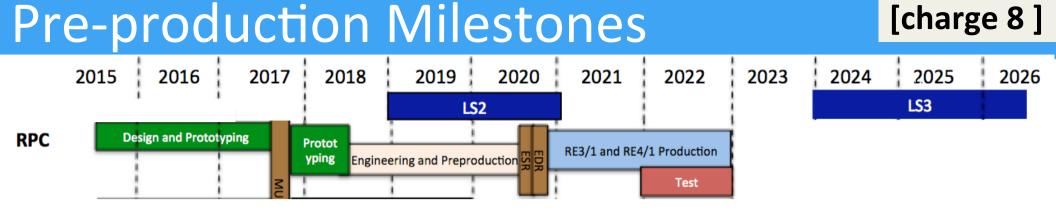


## 2021 main activity: Chamber Assembly and test

RPC Chambers Ready for Assembly Endcap 1 (HL)	HL	February 25, 2021
RPC On-Chamber Electronics(FE) ready (HL)	HL	March 17, 2021
RPC Chambers Ready for Assembly Endcap 2 (HL)	HL	April 22, 2021
RPC Back-end Electronics ready (HL)	HL	December 16, 2021
RPC Detector Ready for Installation Endcap 1 (HL)	HL	December 17, 2021
RPC Installation time window from TC Endcap 1 (TBF)	HL	December 17, 2021

# Ready to Install the first end-cap by December 2021 during the EYETS





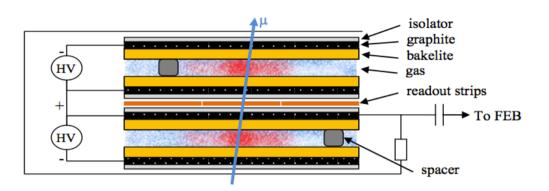
2021 main activity: Chamber Assembly and test

RPC Detector Ready for Installation Endcap 2 (HL)	HL	December 19, 2022
RPC Installation time window from TC Endcap 2 (TBF)	HL	December 19, 2022

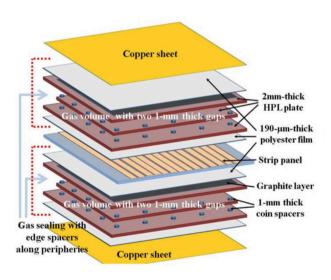
Ready to Install the second end-cap by December 2022 during the EYETS



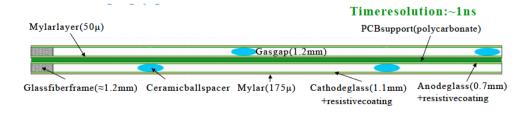
## Relative cost impact of options

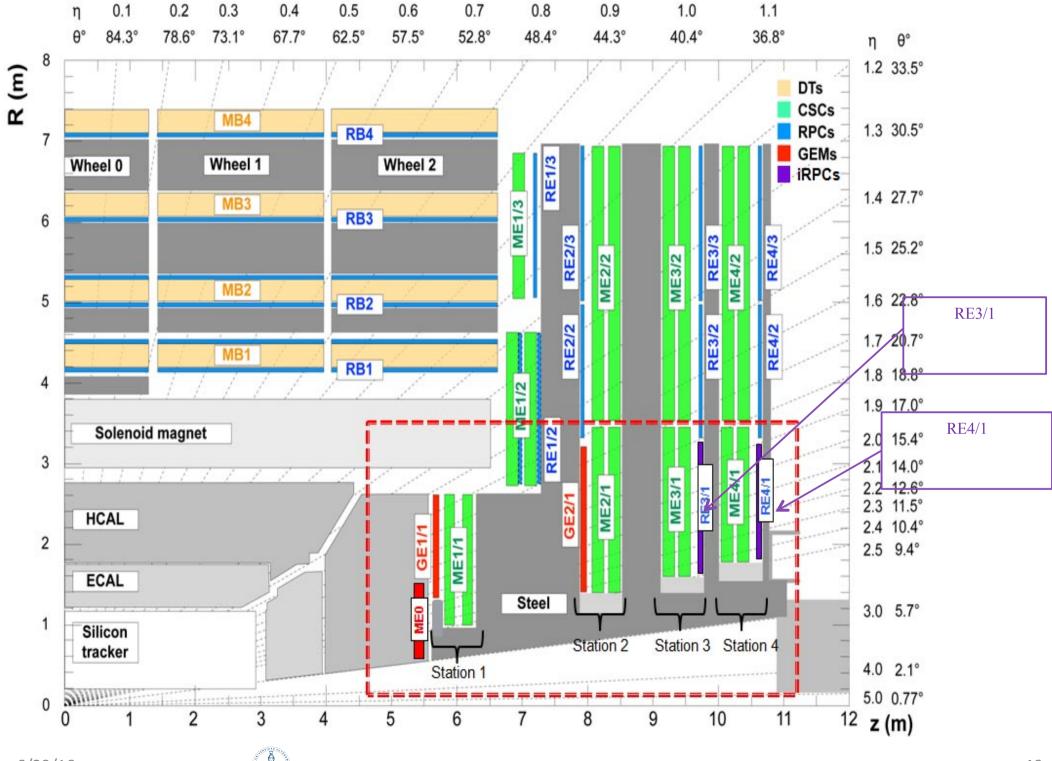


We expect an increment in the cost due to the **New Electronics** 



The price of the material used to build the gaps will increase depending if we use gas or HPL





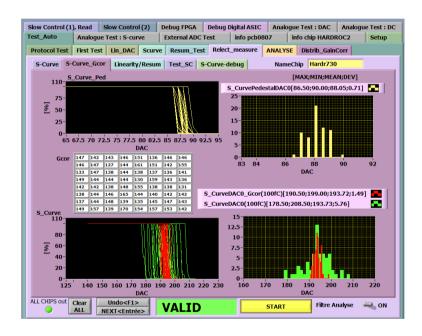
## **Electronics**

### **HARDROC** production

- □ ~10 500 chips were produced and tested with a dedicated test bench in IPNL Lyon for the SDHCAL project (2 months). Yield of > 93%
- ☐ Dedicated Labview program, USB interface, testboard, programmable generator (GPIB), precise multimeter (Keithley)







- ☐Trigger efficiency measurement
  - Pedestal for the 3 shapers
  - □ 100 fC trigger efficiency measurement for fsb0 + gain correction for each channel
  - ☐1 pC trigger efficiency measurement for fsb1 and fsb2



## Draft of construction flow & Quality checks

### Electrode Production HPL/Glass Production site:

Panel Cut, surface inspection, polishing (HPL).

**Quality tests I** 

Thickness, roughness, color, labeling/DB, signal cable (Glass)

### Chamber Elements Production. At Assembly sites:

Front End Boards (FEB) testing.

Quality tests I

• Cooling system, mechanics and readout strip testing.

### Gaps Production. At Assembly sites:

Visual Inspection, Gas tightness and spacer test

**Quality tests II** 

Electrical and dark current, resistivity measurement (sample)

### Chamber Assembly. At sites:

Visual Inspection, Gas tightness, Electrical and dark current

Quality tests III

Connectivity test, Cosmic muon commissioning

#### At CERN final chamber tests:

Detector acceptance for CMS

Quality tests IV

 Leak test, Connectivity, Cooling circuit tests, Long term detector operation at Working Point, Electric and dark current tests

